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NAME OF INVENTOR(S): Takeuchi	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/748,985 Filing Date: 12/30/2003	
TITLE OF INVENTION: CURRENT-SENSE BIAS CIRCUIT FOR A MAGNETORESISTIVE HEAD AND METHOD OF SENSING A CURRENT THERE THROUGH	
TI FILE NO.: TI-36203	DEPOSIT ACCT. NO.: 20-0668
FAXED: <u>1-5-06</u> DUE: 11/22/2005 ATTY/SECY: WDS/tlc	

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